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Data Sheet

1.0 A LED Flash Driver with I²C-Compatible Interface

ADP1649

FEATURES

Ultracompact solution Small, 2 mm × 1.5 mm, 12-ball WLCSP package Smallest footprint, 1 mm height, 1 µH power inductor LED current source for local LED grounding Simplified routing to and from the LED Improved LED thermals Synchronous 3 MHz PWM boost converter, no external diode High efficiency: 90% peak Reduces high levels of input battery current during flash Limits battery current drain in torch mode I²C programmable Currents of up to 1000 mA in flash mode for 1 LED with ±7% accuracy over all conditions Currents of up to 200 mA in torch mode Programmable dc battery current limit (4 settings) Programmable flash timer up to 1600 ms Low VBAT mode to reduce LED current automatically 4-bit ADC for LED V_F, die/LED temperature readback Control I²C-compatible control registers External strobe and torch input pins 2 transmitter mask (TxMASK) inputs Safetv Thermal overload protection Inductor fault detection LED short-circuit and open-circuit protection

APPLICATIONS

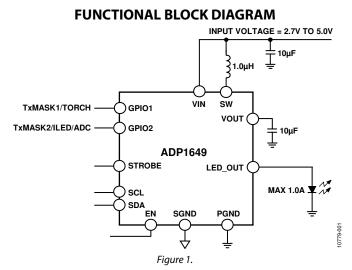
Camera enabled cellular phones and smart phones Digital still cameras, camcorders, and PDAs

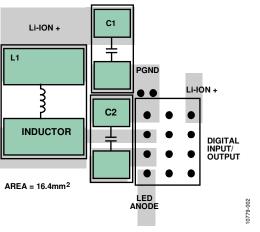
GENERAL DESCRIPTION

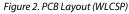
The ADP1649 is a very compact, highly efficient, single white LED flash driver for high resolution camera phones that improves picture and video quality in low light environments. The device integrates a programmable 1.5 MHz or 3 MHz synchronous inductive boost converter, an I²C-compatible interface, and a 1000 mA current source. The high switching frequency enables the use of a tiny, 1 mm high, low cost, 1 μ H power inductor, and the current source permits LED cathode grounding for thermally enhanced, low EMI, and compact layouts.

The LED driver maximizes efficiency over the entire battery voltage range to maximize the input power-to-LED power conversion and to minimize battery current draw during flash

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events. A programmable dc battery current limit safely maximizes LED current for all LED $\rm V_F$ and battery voltage conditions.

Two independent TxMASK inputs permit the flash LED current and battery current to reduce quickly during a power amplifier current burst. The I²C-compatible interface enables the programmability of timers, currents, and status bit readback for monitoring the operation and for safety control.

The ADP1649 is available in a compact 12-ball, 0.5 mm pitch WLCSP package, and operates within specification over the full -40° C to $+125^{\circ}$ C junction temperature range.

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ADP1649* PRODUCT PAGE QUICK LINKS

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COMPARABLE PARTS

View a parametric search of comparable parts.

EVALUATION KITS

• ADP1649 Evaluation Board

DOCUMENTATION

Data Sheet

 ADP1649: 1.0 A LED Flash Driver with I²C-Compatible Interface Data Sheet

REFERENCE MATERIALS

Press

Analog Devices Expands Industry Leading Flash LED
 Driver Portfolio

DESIGN RESOURCES

- ADP1649 Material Declaration
- PCN-PDN Information
- Quality And Reliability
- Symbols and Footprints

DISCUSSIONS

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SAMPLE AND BUY

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REVISION HISTORY

7/12—Revision 0: Initial Version

SPECIFICATIONS

 V_{IN}^{1} = 3.6 V, T_J = -40°C to +125°C for minimum/maximum specifications, and T_A = 25°C for typical specifications, unless otherwise noted.

Test Conditions/Comments	Min	Тур	Max	Unit
	2.7		5.0	V
V _{IN} falling	2.3	2.4	2.5	V
	50	100	150	mV
$T_1 = -40^{\circ}$ C to +85°C, current into VIN pin, $V_{IN} = 2.7$ V to 4.5 V		0.2	1	μA
$T_1 = -40^{\circ}$ C to +85°C, current into VIN pin, $V_{IN} = 2.7$ V to 4.5 V		3	10	μA
Torch mode, LED current = 100 mA		5.3		mA
$T_1 = -40^{\circ}C \text{ to } +85^{\circ}C, V_{SW}^{3} = 4.5 \text{ V}$			2	μA
			0.5	μA
				<u> </u>
Assist light value setting = 0 (000 binary)		25		mA
Assist light value setting = 7 (111 binary)		200		mA
Flash value setting = 0 (00000 binary)		300		mA
Flash value setting = 14 (01110 binary)		1000		mA
	-6		+6	%
	-7		+7	%
	-10		+10	%
	-15		+15	%
		265		mV
				mV
			0.6	ms
				ms
Switching frequency = 3 MHz	2.8	3	3.2	MH
				MH
				%
				%
		60		mΩ
				mΩ
	4.575	5.000	5.425	v
				mA
$I_{\rm cup}$ at VOUT = 300 mA		03		%/\
				%//
		0.7		/0/1
1000 mA LED current		530		mV
				mV
		400		
				mV
200 mA LED current		380		
	$V_{IN} falling$ $T_{J} = -40^{\circ}C \text{ to } +85^{\circ}C, \text{ current into VIN pin, } V_{IN} = 2.7 \text{ V to } 4.5 \text{ V}$ $T_{J} = -40^{\circ}C \text{ to } +85^{\circ}C, \text{ current into VIN pin, } V_{IN} = 2.7 \text{ V to } 4.5 \text{ V}$ Torch mode, LED current = 100 mA $T_{J} = -40^{\circ}C \text{ to } +85^{\circ}C, V_{SW}^{3} = 4.5 \text{ V}$ $T_{J} = 25^{\circ}C, V_{SW}^{3} = 4.5 \text{ V}$ Assist light value setting = 0 (000 binary) Assist light value setting = 7 (111 binary)	V_{IN} falling2.7 V_{IN} falling2.3 $T_{J} = -40^{\circ}C$ to +85°C, current into VIN pin, $V_{IN} = 2.7$ V to 4.5 VTorch mode, LED current = 100 mA $T_{J} = -40^{\circ}C$ to +85°C, $V_{SW}^{3} = 4.5$ VT_{J} = -40^{\circ}C to +85°C, $V_{SW}^{3} = 4.5$ VT_{J} = -40^{\circ}C to +85°C, $V_{SW}^{3} = 4.5$ VAssist light value setting = 0 (000 binary)Assist light value setting = 14 (01110 binary)Flash value setting = 14 (01110 binary)ILED = 700 mA to 1000 mA $I_{LED} = 75$ mA to 200 mA $I_{LED} = 25$ mA to 50 mAFlash, 1000 mA LED currentSwitching frequency = 3 MHzSwitching frequency = 1.5 MHz1000 mA LED current	V_{IN} falling 2.7 V_{IN} falling 2.3 2.4 $T_{J} = -40^{\circ}$ C to +85°C, current into VIN pin, $V_{IN} = 2.7$ V to 4.5 V 50 100 $T_{J} = -40^{\circ}$ C to +85°C, current into VIN pin, $V_{IN} = 2.7$ V to 4.5 V 3 5.3 Torch mode, LED current = 100 mA 5.3 5.3 5.3 $T_{J} = -40^{\circ}$ C to +85°C, $V_{SW}^3 = 4.5$ V 200 3 5.3 $T_{J} = -26^{\circ}$ C, $V_{SW}^3 = 4.5$ V 200 300 1000 1000 Hash value setting = 0 (0000 binary) 25 200 300 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000 1000	V_{IN} falling 2.7 5.0 $T_j = -40^{\circ}$ C to +85°C, current into VIN pin, $V_{IN} = 2.7$ V to 4.5 V 2.3 2.4 2.5 50 100 150 0.2 1 $T_j = -40^{\circ}$ C to +85°C, current into VIN pin, $V_{IN} = 2.7$ V to 4.5 V 3 10 Torch mode, LED current = 100 mA 5.3 2 1 $T_j = -40^{\circ}$ C to +85°C, $V_{SW}^3 = 4.5$ V 2 0.5 0.5 Assist light value setting = 0 (0000 binary) 5.3 200 5 Assist light value setting = 0 (0000 binary) 200 1000 1000 Flash value setting = 14 (01110 binary) 200 1000 1000 I_{LD} = 700 mA to 1000 mA -6 +6 -7 -7 I_{LD} = 75 mA to 200 mA -10 -10 -10 -10 I_{LD} = 25 mA to 50 mA -15 +15 265 -15 +15 Flash, 1000 mA LED current 0.6 0.1 -16 -16 -16 -16 Switching frequency = 3 MHz 2.8 3 3.2 -14 -15

Parameter ²	Test Conditions/Comments	Min	Тур	Мах	Unit
DIGITAL INPUTS/GPIOx					
Input Logic					
Low Voltage				0.54	V
High Voltage		1.26			V
GPIO1, GPIO2, STROBE Pull-Down			390		kΩ
Torch Glitch Filtering Delay	From torch rising edge to device start	5.5	7	7.5	ms
INDICATOR LED					
LED Current Accuracy		-22		+22	%
Short-Circuit Detection Threshold				1.2	V
Open-Circuit Detection Threshold		2.45			v
ADC					
Resolution		4			Bits
Error	External voltage mode		0	±1	LSB
	V_F mode, $T_J = 25^{\circ}C$			±1	LSB
	V_F mode, $T_J = -40^{\circ}$ C to $+125^{\circ}$ C			±1.5	LSB
Input Voltage Range, GPIO2	External voltage mode	0		0.5	V
SAFETY FEATURES					
Maximum Timeout For Flash			1600		ms
Timer Accuracy		-7.0		+7.0	%
DC Current Limit	DC current value setting = 0 (00 binary)	1.35	1.5	1.65	Α
	DC current value setting = 1 (01 binary)	1.55	1.75	1.95	Α
	DC current value setting = 2 (10 binary)	1.8	2.0	2.2	А
Low VBAT Mode Transition Voltage					
Error				3.2	%
Hysteresis			50		mV
Coil Peak Current Limit	Peak current value setting = 0 (00 binary)	1.55	1.75	1.95	Α
	Peak current value setting = 1 (01 binary)	2.02	2.25	2.5	Α
	Peak current value setting = 2 (10 binary)	2.47	2.75	3.0	Α
Overvoltage Detection Threshold		5.15	5.5	5.9	V
LED_OUT Short-Circuit Detection Comparator Reference Voltage			1.2	1.3	V
Thermal Shutdown Threshold					
T, Rising			150		°C
T ₁ Falling			140		°C

 1 V_{IN} is the input voltage to the circuit. 2 All limits at temperature extremes are guaranteed via correlation using standard statistical quality control (SQC). 3 V_{SW} is the voltage on the SW switch pin.

RECOMMENDED SPECIFICATIONS: INPUT AND OUTPUT CAPACITANCE AND INDUCTANCE

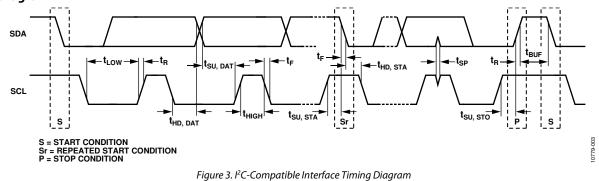
Table 2.						
Parameter	Symbol	Test Conditions/Comments	Min	Тур	Max	Unit
CAPACITANCE	C _{MIN}					
Input		$T_{A} = -40^{\circ}C \text{ to } +125^{\circ}C$	4.0	10		μF
Output		$T_{A} = -40^{\circ}C \text{ to } +125^{\circ}C$	3.0	10	20	μF
MINIMUM AND MAXIMUM INDUCTANCE	L	$T_{A} = -40^{\circ}C \text{ to } +125^{\circ}C$	0.6	1.0	1.5	μH

I²C-COMPATIBLE INTERFACE TIMING SPECIFICATIONS

Table 3.				
Parameter ¹	Min	Мах	Unit	Description
f _{scl}		400	kHz	SCL clock frequency
t _{HIGH}	0.6		μs	SCL high time
t _{LOW}	1.3		μs	SCL low time
t _{su, dat}	100		ns	Data setup time
t _{hd, dat}	0	0.9	μs	Data hold time
t _{su, sta}	0.6		μs	Setup time for repeated start
t _{hd, sta}	0.6		μs	Hold time for start/repeated start
t _{BUF}	1.3		μs	Bus free time between a stop and a start condition
t _{su, sto}	0.6		μs	Setup time for a stop condition
t _R	$20 + 0.1 C_B^2$	300	ns	Rise time of SCL and SDA
t _F	$20 + 0.1 C_B^{2}$	300	ns	Fall time of SCL and SDA
t _{sP}	0	50	ns	Pulse width of suppressed spike
C _B ²		400	рF	Capacitive load for each bus line

 1 Guaranteed by design. $^2\,C_{\scriptscriptstyle B}$ is the total capacitance of one bus line in picofarads.

Timing Diagram



ABSOLUTE MAXIMUM RATINGS

Table 4.

1 4010 1.	
Parameter	Rating
VIN, SDA, SCL, EN, GPIO1, GPIO2, STROBE, LED_OUT, SW, VOUT to Power Ground	–0.3 V to +6 V
PGND to SGND	–0.3 V to +0.3 V
Ambient Temperature Range (T _A)	-40°C to +85°C
Junction Temperature Range (T _J)	-40°C to +125°C
Storage Temperature	JEDEC J-STD-020
ESD Models	
Human Body	±2000 V
Charged Device	±500 V
Machine	±150 V

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

THERMAL DATA

Exceeding the junction temperature limits may damage the ADP1649. Monitoring T_A does not guarantee that T_J is within the specified temperature limits. In applications with high power dissipation and poor thermal resistance, the maximum T_A may need to be derated. In applications with moderate power dissipation and low printed circuit board (PCB) thermal resistance, the maximum T_A can exceed the maximum limit as long as the T_J is within specification limits. T_J of the device is dependent on the T_A, the power dissipation (PD) of the device, and the junction-to-ambient thermal resistance (θ_{JA}) of the package. Maximum T_J is calculated from T_A and PD using the following formula:

$$T_J = T_A + (PD \times \theta_{JA})$$

THERMAL RESISTANCE

 θ_{JA} of the package is based on modeling and calculation using a 4-layer board. θ_{JA} is highly dependent on the application and board layout. In applications where high maximum power dissipation exists, attention to thermal board design is required. The value of θ_{JA} may vary, depending on PCB material, layout, and environmental conditions. The specified value of θ_{JA} is based on a 4-layer, 4 in × 3 in, 2½ oz copper board, per JEDEC standards. For more information, see the AN-617 Application Note, *MicroCSP^{**} Wafer Level Chip Scale Package*.

 θ_{IA} is specified for a device mounted on a JEDEC 2s2p PCB.

Table 5. Thermal Resistance

Package Type	θ _{JA}	Unit
12-Ball WLCSP	75	°C/W

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

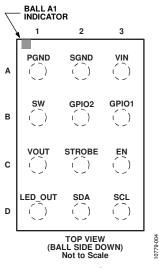


Figure 4. Pin Configuration

Table 6. Pin Function Descriptions

Pin No.	Mnemonic	Description
A1	PGND	Power Ground.
A2	SGND	Signal Ground.
A3	VIN	Input Voltage for the Device. Connect an input bypass capacitor close to this pin.
B1	SW	Boost Switch. Connect the power inductor between SW and the input capacitor.
B2	GPIO2	General-Purpose Input/Output for the ILED/TxMASK2/ADC Modes. These modes are register selectable. This is a multifunction pin for the red indicator LED current source, TxMASK2, or ADC input.
		ILED Mode. For the ILED mode, connect this pin to the red LED anode. Connect the LED cathode to power ground.
		TxMASK2 Mode. TheTxMASK2 function of this pin reduces the current to the programmable TxMASK2 current.
		ADC Mode. The ADC function of this pin is used as the input pin for the ADC.
B3	GPIO1	General-Purpose Input/Output for the Torch/TxMASK1 Modes. These modes are register selectable. This is a multifunction pin for the external torch mode or TxMASK1 input.
		Torch Mode. Enables the integrated circuit (IC) in direct torch mode.
		TxMASK1 Mode. Reduces the flash current to the programmable TxMASK1 current.
C1	VOUT	Boost Output. Connect an output bypass capacitor very close to this pin. VOUT is the output for the 5 V external voltage mode.
C2	STROBE	Strobe Signal Input. STROBE synchronizes the flash pulse to the image capture. In most cases, this signal comes directly from the image sensor.
C3	EN	Enable. Set EN low to bring the quiescent current (I _Q) to <1 μ A. Registers are set to their defaults when EN is brought from low to high.
D1	LED_OUT	LED Current Source. Connect the LED_OUT pin to the anode of the flash LED.
D2	SDA	I ² C Data Signal in I ² C Mode.
D3	SCL	I ² C Clock Signal in I ² C Mode.

TYPICAL PERFORMANCE CHARACTERISTICS

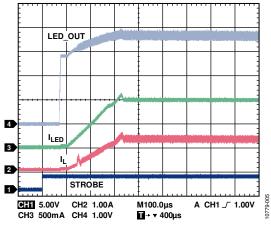
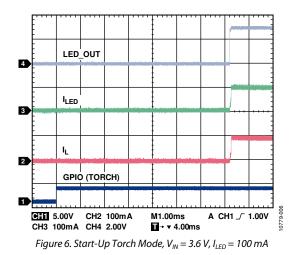


Figure 5. Start-Up Flash Mode, V_{IN} = 3.6 V, I_{LED} = 1000 mA



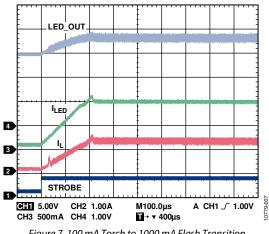


Figure 7. 100 mA Torch to 1000 mA Flash Transition

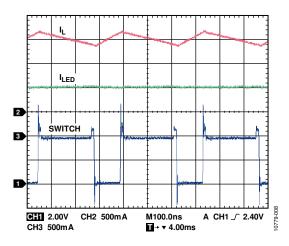
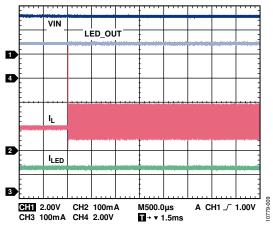
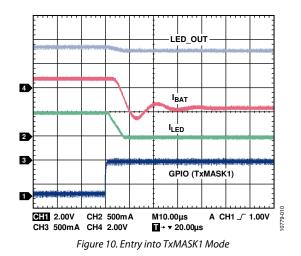


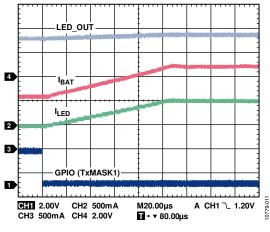
Figure 8. Switching Waveforms, Flash Mode, $I_{LED} = 1000 \text{ mA}$

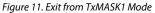


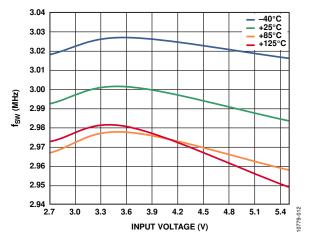


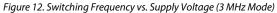


Data Sheet









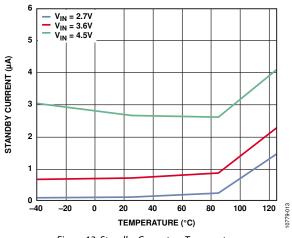
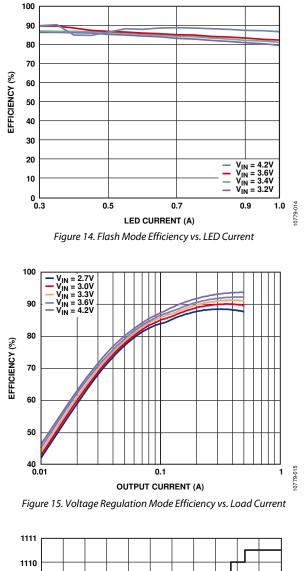
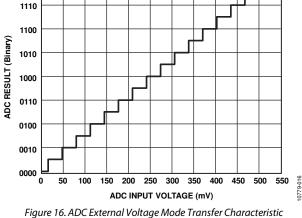


Figure 13. Standby Current vs. Temperature





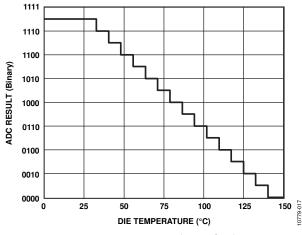
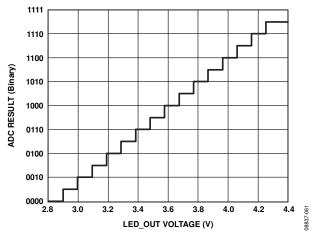


Figure 17. ADC Die Temperature Mode Transfer Characteristic





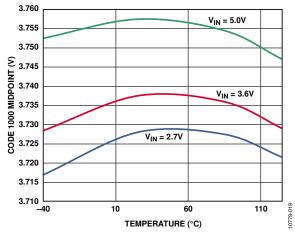


Figure 19. ADC LED V_F Mode, Code 1000, Midpoint vs. Temperature

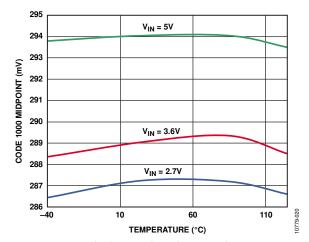
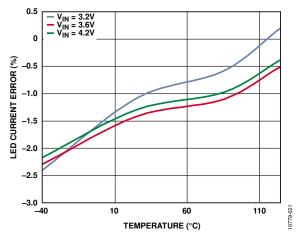
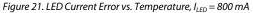


Figure 20. ADC External Voltage Mode, Code 1000, Midpoint vs. Temperature





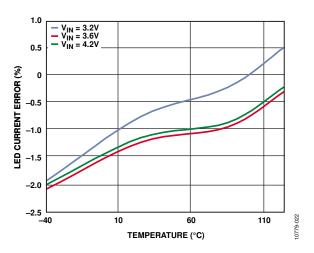


Figure 22. LED Current Error vs. Temperature, $I_{LED} = 1000 \text{ mA}$

THEORY OF OPERATION

The ADP1649 is a high power, I²C programmable, white LED driver ideal for driving white LEDs for use as a camera flash. The ADP1649 includes a boost converter and a current regulator suitable for powering one high power white LED.

WHITE LED DRIVER

The ADP1649 drives a synchronous 3 MHz boost converter as required to power the high power LED. If the sum of the LED forward voltage and current regulator voltage is higher than the battery voltage, the boost turns on. If the battery voltage is higher than the sum of the LED V_F and current regulator voltage, the boost is disabled and the part operates in pass through mode. The ADP1649 uses an integrated PFET high-side current regulator for accurate brightness control.

MODES OF OPERATION

After the enable pin is high, the device can be set into the four modes of operation using the LED_MOD bits in Register 0x04, via the I²C-compatible interface.

Table 7. LED	_MOD Bit Settings, I ² C-Compatible Interface

LED_MOD	
Setting	Description
00	Sets the device to standby mode, consuming 3 µA typical.
01	Sets the device to fixed VOUT = 5 V output mode.
10	Sets the device to assist light mode with continuous LED current.
11	Sets the device to flash mode with an available current of up to 1 A for 1.6 sec.

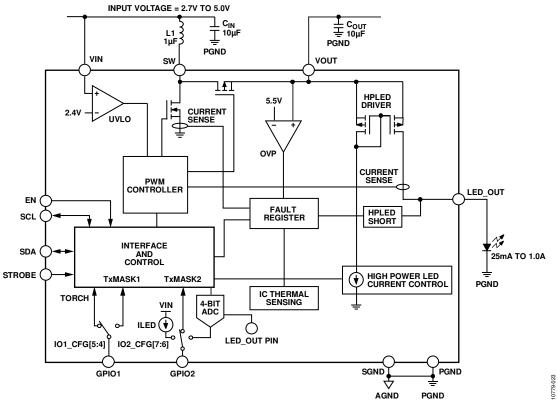


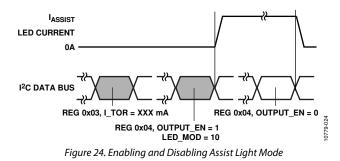
Figure 23. Detailed Block Diagram

Data Sheet

ASSIST LIGHT

The assist light mode provides a continuous current that is programmable from 25 mA to 200 mA. Set the assist light current using the I_TOR bits (in Register 0x03).

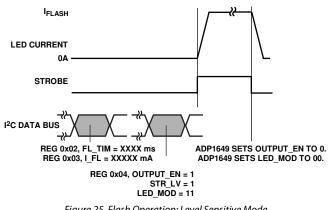
To enable assist, set LED_MOD to assist light mode and set OUTPUT_EN = 1 (in Register 0x04). Disable assist light mode by setting LED_MOD to standby mode or setting OUTPUT_EN = 0.

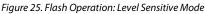


FLASH MODE

Flash mode provides 300 mA to 1 A for a programmable time of up to 1.6 seconds. Set the flash current using the I_FL bits (in Register 0x03) and the maximum flash duration with the FL TIM bits (in Register 0x02). To enable flash mode, set LED_MOD to flash mode and set OUTPUT_EN = 1. Enable flash without the STROBE pin by setting STR_MODE (in Register 0x04) to 0 (software strobe).

When STR_MODE is in hardware strobe mode, setting the STROBE pin high enables flash and synchronizes it to the image sensor. Hardware strobe mode has two modes for timeout: level sensitive (STR_LV = 1, Register 0x04) and edge sensitive $(STR_LV = 0, Register 0x04).$





In level sensitive mode, the duration of the STROBE pin set to high sets the duration of the flash up to the maximum time indicated by the FL_TIM timeout. If STROBE remains high longer than the duration set by FL_TIM, a timeout fault disables the flash.

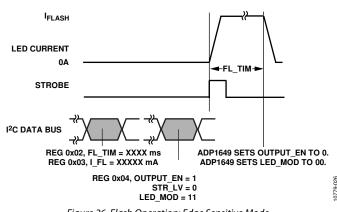
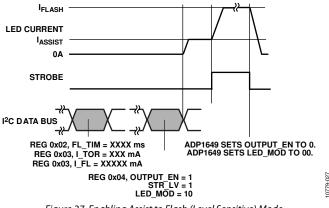
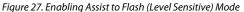


Figure 26. Flash Operation: Edge Sensitive Mode

In edge sensitive mode, a positive edge on the STROBE pin enables the flash, and the FL_TIM bits set the flash duration.

ASSIST TO FLASH OPERATION

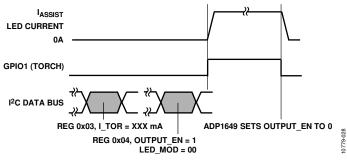




The STR_POL bit in Register 0x07 changes the default enable of the STROBE pin from low to high and from high to low. Additional image sensor specific assist/flash enable modes are included in the device, and information on these modes is available by request from the Analog Devices, Inc., sales team.

TORCH MODE

Set the assist/torch light current modes using the I_TOR bits. To enable torch mode using a logic signal, set LED_MOD to standby mode, set OUTPUT_EN = 1, and bring GPIO1 high. Disable the external torch mode by setting GPIO1 low or programming OUTPUT_EN = 0. Bringing GPIO1 low during torch mode automatically sets OUTPUT_EN = 0. To reenable torch mode, program OUTPUT_EN = 1 and bring GPIO high again.



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TORCH TO FLASH MODE

The driver can move directly from external torch mode (using GPIO1) to flash mode by bringing the STROBE pin high before bringing the GPIO1 pin (set for the torch mode) low. Bringing torch low before the STROBE pin goes high prevents the flash from firing when the STROBE pin goes high.

The ADP1649 returns to standby mode after a successful flash and sets OUTPUT_EN = 0.

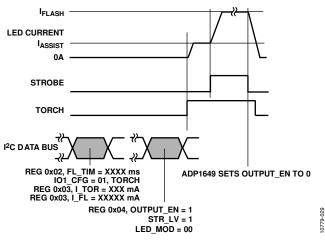


Figure 29. Enabling Flash Mode from External Torch Mode

TxMASK OPERATION

When the ADP1649 is in flash mode, the TxMASK1 and the TxMASK2 functions reduce the battery load in response to the system enabling a power amplifier. The device remains in flash mode, but the LED driver output current reduces to the programmed TxMASK light level in less than 21 µs.

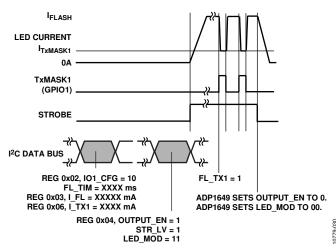


Figure 30. TxMASK1 Operation During Flash (Level Sensitive) Mode

The device selects the TxMASK1 or TxMASK2 current level based on whether the TxMASK1 or TxMASK2 input is used. Anytime TxMASK1 or TxMASK2 is brought high during a flash event, a flag is set in the fault information register. To avoid overshoots on the battery current, when the TxMASK signal goes low again, the LED current returns to the full flash level in a controlled manner. If both TxMASK inputs are set high simultaneously, the TxMASK1 current level is used.

FREQUENCY FOLDBACK

Frequency foldback is an optional mode that optimizes efficiency by reducing the switching frequency to 1.5 MHz when VIN is slightly less than VOUT. Enable frequency foldback by setting FREQ_FB = 1 in Register 0x04.

INDICATOR LED DRIVER

The indicator LED driver on GPIO2 provides a programmable current source of between 2.75 mA and 11 mA for driving a red privacy LED; the I_ILED bits in Register 0x07 program the current level. The circuit consists of a programmable current source and a monitoring circuit that uses comparators to determine whether the indicator LED is short circuit or open circuit. The threshold for detection of a short circuit is 1.2 V (maximum), and for an open circuit, the threshold is 2.45 V (minimum). The indicator LED must not be used at the same time as a flash or an assist/ torch event.

LOW BATTERY LED CURRENT FOLDBACK

As the battery discharges, the lower battery voltage results in higher peak currents through the battery ESR, which may cause early shutdown of the phone. The ADP1649 features an optional low battery detection option that reduces the flash current (to a programmable level) when the battery voltage falls below a programmable level. Set V_VB_LO = 000 to disable the low battery current foldback (see Table 8 for details).

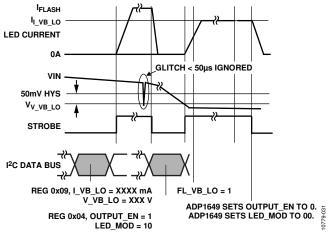


Figure 31. Register 0x09 Sets the Battery Voltage Threshold Level and the Reduced LED Current Level

Bit Name	V _{DD} Level
V_VB_LO	000 = disabled (default)
	001 = 3.3 V
	010 = 3.35 V
	011 = 3.4 V
	100 = 3.45 V
	101 = 3.5 V
	110 = 3.55 V
	111 = 3.6 V

Table 8. V_{DD} Level at Which the V_{BAT} Low Function Is Enabled

PROGRAMMABLE BATTERY DC CURRENT LIMIT

The ADP1649 has four optional programmable input dc current limits that limit the maximum input battery current over all conditions. This allows use of higher LED currents in a system with significant variation in LED forward voltage (V_F) and supply battery voltage without risk of exceeding the current allocated to the flash.

Bit Name	Current Limit
IL_DC	00 = 1.5 A
	01 = 1.75 A
	10 = 2.0 A (default)
	11 = reserved

During startup of the flash, if the battery current does not reach the dc current limit, the LED current is set to the current value of the I_FL bits. If the battery current reaches the programmed dc current limit on startup, the LED current does not increase further. The dc current limit flag is set in the fault information register. The I_FL bits in Register 0x03 are set to the automatically reduced current-limit LED current and are available for readback.

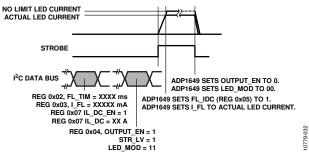


Figure 32. DC Current-Limit Operation in a Low Battery, High LED V_F Case

The camera system shown in Figure 33 can adjust the image sensor settings based on the known reduced LED current for a low battery and a high V_F LED.

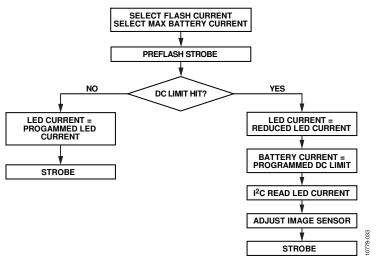


Figure 33. Use of the DC Current Limit in an Optimized Camera System

ANALOG-TO-DIGITAL CONVERTER OPERATION

The internal 4-bit analog-to-digital converter (ADC) is configurable to measure the LED V_F , the integrated circuit (IC) die temperature, or to measure an external voltage using the GPIO2 pin. Read the 4-bit resolution output code from Register 0x08 using the I²C interface.

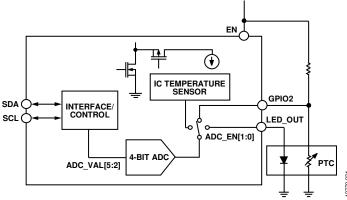


Figure 34. Available ADC Modes

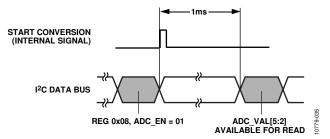
The ADC can perform the conversion immediately on an I^2C command or it can delay the conversion until the next time the ADP1649 exits an active mode. Delayed conversion can be useful, for example, for measuring the IC temperature at the end of a timed flash period.

To set up a delayed conversion, set ADC_EN to the required mode while OUTPUT_EN = 0. Next, set the ADP1649 to the desired output mode (torch, flash assist light, or 5 V output) and set OUTPUT_EN = 1. The ADC conversion is performed when the ADP1649 exits the chosen mode.

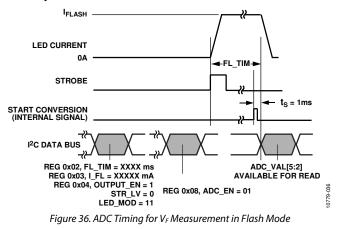
To perform an immediate conversion, set ADC_EN to the required mode during ADP1649 operation (OUTPUT_EN = 1). Note that an ADC conversion cannot be performed when the ADP1649 is idle. This is interpreted as an attempt to set up a delayed conversion.

LED V_F Mode

The ADC can measure the LED V_F in both flash and assist/torch modes. In torch mode, set ADC_EN = 01 to begin a conversion. The value can be read back from the ADC_VAL[5:2] bits 1 ms after the conversion has started. Assist/torch mode, rather than flash mode, is best in the handset production test to verify the LED V_F .



In flash mode, set ADC_EN = 01. The conversion occurs immediately before the timeout; therefore, the FL_TIM bits set when the ADC sample occurs. This allows the V_F to settle from the initial peak as the junction temperature of the LED stabilizes. An LED temperature vs. flash time profile for the handset PCB design can be generated during the design phase by varying the FL_TIM bits from the lowest to the highest setting and collecting a V_F sample on each flash.



Die Temperature Mode

The ADC measures the IC die temperature and provides the result to the I²C interface. This is useful during the design phase of the flash system to optimize PCB layout for the best thermal design.

Write $ADC_EN = 10$ to begin a die temperature measurement. The value can be read back from the $ADC_VAL[5:2]$ bits 1 ms after the conversion has started. The most stable and accurate value of the die temperature is available at the end of the flash pulse.

External Voltage Mode

The ADC measures the voltage on the GPIO2 pin when the GPIO2 is configured as an ADC input by setting $IO2_CFG = 11$. One example is using an external temperature dependent resistor to create a voltage based on the temperature of the flash LED. The EN line can be used for biasing to reduce leakage current when the flash is not being used.

5 V OUTPUT OPERATION

The ADP1649 can be used as a 5 V boost to supply up to 500 mA for an audio voltage rail or keypad LED driver voltage. To move into voltage regulation mode, the OUTPUT_EN bit must be set to 0. To enable the 5 V output, set LED_MOD[1:0] = 01, and set OUTPUT_EN = 1. The ADP1649 sets the VOUT pin to 5 V and disconnects VOUT from LED_OUT. The VOUT pin is connected to the SW node when the ADP1649 is not enabled. Do not connect VOUT directly to a positive external voltage source because this causes current to flow from VOUT to the battery.

Figure 35. ADC Timing for All Modes Except V_F Measurement in Flash Mode

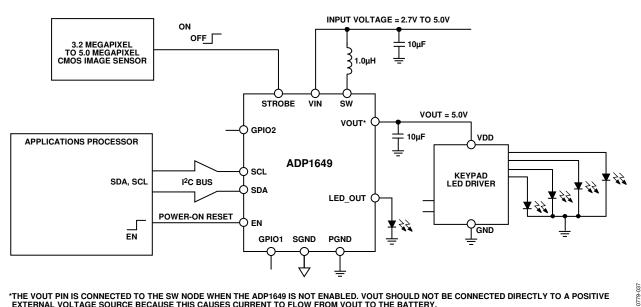




Figure 37. Voltage Regulation Mode: LED Driver Application

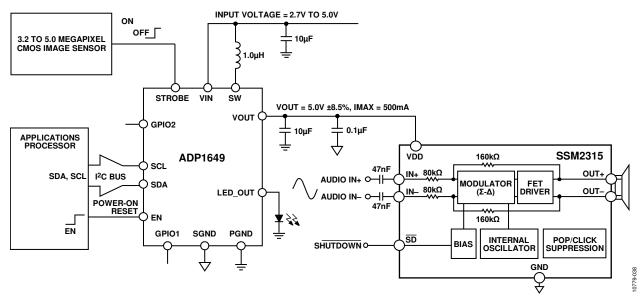


Figure 38. Voltage Regulation Mode: Class-D Audio Application

SAFETY FEATURES

For critical fault conditions, such as output overvoltage, flash timeout, LED output short-circuit, and overtemperature conditions, the ADP1649 has built-in protection modes. If a critical fault occurs, OUTPUT_EN (Register 0x04) is set to 0, and the driver shuts down. The appropriate fault bit is set in the fault information register (Register 0x05). The processor can read the fault information register through the I²C interface to determine the nature of the fault condition. When the fault register is read, the corresponding fault bit is cleared.

If a noncritical event such as an indicator LED open-circuit, short-circuit, TxMASK1, or TxMASK2 event occurs, or if the dc or soft inductor current limit is reached, the LED driver continues operating. The corresponding information bits are set in the fault information register until the processor reads them.

SHORT-CIRCUIT FAULT

When the flash driver is disabled, the high-side current regulator disconnects the dc path between the battery and the LED, protecting the system from an LED short circuit. The LED_OUT pin features short-circuit protection that monitors the LED voltage when the LED driver is enabled. If the LED_OUT pin remains below the short-circuit detection threshold, a short circuit is detected. Bit 6 of the fault information register is set high. The ADP1649 remains disabled until the processor clears the fault register.

OVERVOLTAGE FAULT

The ADP1649 contains a comparator at the VOUT pin that monitors the voltage between VOUT and GND. If the voltage exceeds 5.5 V (typical), the ADP1649 shuts down. Bit 7 in the fault information register is read back as high. The ADP1649 is disabled until the fault is cleared, ensuring protection against an open circuit.

DYNAMIC OVERVOLTAGE MODE (DOVP)

Dynamic OVP mode is a programmable feature that limits the VOUT voltage exceeding the OVP level while maintaining as much current as possible through the LED. This mode prevents an overvoltage fault in the case of a much higher than expected LED forward voltage. If the LED forward voltage reduces due to the LED temperature rising, the ADP1649 moves out of DOVP mode and regulates the LED at the programmed current level. Set Bit 7 of Register 0x07 high to enable the DOVP mode.

TIMEOUT FAULT

When the external strobe mode is enabled (Register 0x04, Bit 2) and the strobe enable bit is set to the level sensitive mode (Register 0x04, Bit 5), then, if the STROBE pin remains high for longer than the programmed timeout period, the timeout fault bit (Register 0x05, Bit 4) is read back as high. The ADP1649 remains disabled until the processor clears the fault register.

OVERTEMPERATURE FAULT

When the junction temperature of the ADP1649 rises above 150°C, a thermal protection circuit shuts down the device. Bit 5 of the fault information register is set high. The ADP1649 remains disabled until the processor clears the fault register.

INDICATOR LED FAULT

The GPIO2 pin features open-circuit and short-circuit protection in the indicator LED mode. If a short circuit or open circuit occurs, Bit 2 of the fault information register is set high. The indicator LED regulator ensures that no damage occurs to the IC during a fault.

CURRENT LIMIT

The internal switch limits battery current by ensuring that the peak inductor current does not exceed the programmed limit (Bit 6 and Bit 7 in Register 0x04 set the current limit). The default mode of the ADP1649 is soft current-limit mode. If the peak inductor current limit is reached, Bit 1 of the fault information register is set, and the inductor and LED current cannot increase further although the ADP1649 continues to operate. If the ADP1649 has soft current limit disabled and the peak inductor current exceeds the limit, the device shuts down and Bit 1 of the fault information register is set high. In this case, the ADP1649 remains disabled until the processor clears the fault register.

INPUT UNDERVOLTAGE

The ADP1649 includes a battery undervoltage lockout circuit. During 5 V or LED operation, the battery voltage dropping below the 2.4 V (typical) input UVLO threshold shuts down the ADP1649. A power-on reset circuit resets the registers to their default conditions when the voltage rises above the UVLO rising threshold.

SOFT START

The ADP1649 has a soft start mode that controls the rate of increase of battery current at startup by digitally controlling the output current ramp. The maximum soft start time is 0.6 ms.

RESET USING THE ENABLE (EN) PIN

A low to high transition on the EN pin resets all registers to their default values. Bringing EN low reduces the I_Q to 0.2 μA (typical).

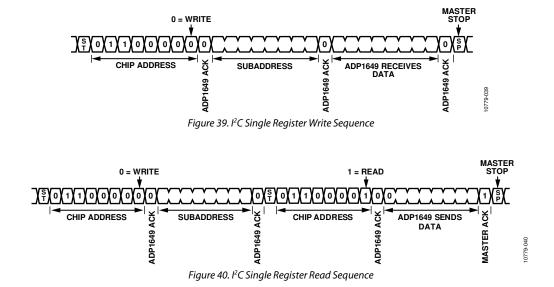
CLEARING FAULTS

The information bits and faults in Register 0x05 automatically clear when the processor reads the fault register.

I²C INTERFACE

The ADP1649 includes an I²C-compatible serial interface for control of the LED current, as well as for readback of the system status registers. The I²C chip address is 0x30 (0x60 in write mode and 0x61 in read mode). Additional I²C addresses are available on request.

Figure 39 illustrates the I²C write sequence to a single register. The subaddress content selects which of the nine ADP1649 registers is written to. The ADP1649 sends an acknowledgment to the master after the 8-bit data byte has been written. Figure 40 shows the I²C read sequence of a single register. See the I²C Register Map section for a list of register definitions.



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I²C REGISTER MAP

The lowest bit number (0) represents the least significant bit, the highest bit number (7) represents the most significant bit, and R/W indicates whether the bit is read only (R), write only (W), or both read and write (R/W).

Bit	Bit Name	R/W	Reset State
[7:0]	Manufacturer Information	R	00100010

Table 11. V	Table 11. VREF and Timer Register (Register 0x02)					
Bit	Bit Name	R/W	Description			
[7:6]	IO2_CFG	R/W	GPIO2 configuration			
			00 = high impedance (default)			
			01 = indicator LED			
			10 = TxMASK2 operation mode			
			11 = analog input (to ADC)			
[5:4]	IO1_CFG	R/W	GPIO1 configuration			
			00 = high impedance (default)			
			01 = torch			
			10 = TxMASK1 operation mode			
			11 = reserved			
[3:0]	FL_TIM	R/W	Flash timer value setting			
			0000 = 100 ms			
			0001 = 200 ms			
			0010 = 300 ms			
			0011 = 400 ms			
			0100 = 500 ms			
			0101 = 600 ms			
			0110 = 700 ms			
			0111 = 800 ms			
			1000 = 900 ms			
			1001 = 1000 ms			
			1010 = 1100 ms			
			1011 = 1200 ms			
			1100 = 1300 ms			
			1101 = 1400 ms			
			1110 = 1500 ms			
			1111 = 1600 ms (default)			

Table 12. Current Set Register (Register 0x03)

Bit	Bit Name	R/W	Description
[7:3]	I_FL	R/W	Flash current value setting
			00000 = 300 mA
			00001 = 350 mA
			00010 = 400 mA
			00011 = 450 mA
			00100 = 500 mA
			00101 = 550 mA
			00110 = 600 mA
			00111 = 650 mA
			01000 = 700 mA
			01001 = 750 mA
			01010 = 800 mA
			01011 = 850 mA
			01100 = 900 mA
			01101 = 950 mA
			01110 = 1000 mA (default)
			Codes above 01110 are reserved
[2:0]	I_TOR	R/W	Torch and assist light current value setting
			000 = 25 mA
			001 = 50 mA
			010 = 75 mA
			011 = 100 mA (default)
			100 = 125 mA
			101 = 150 mA
			110 = 175 mA
			111 = 200 mA

Bit	Bit Name	R/W	Description
[7:6]	IL_PEAK	R/W	Inductor peak current-limit setting
			00 = 1.75 A
			01 = 2.25 A
			10 = 2.75 A (default)
			11 = reserved
5	STR_LV	R/W	0 = edge sensitive
			1 = level sensitive (default)
4	FREQ_FB	R/W	0 = frequency foldback to 1.5 MHz not allowed (default)
			1 = frequency foldback to 1.5 MHz allowed
3	OUTPUT_EN	R/W	0 = output off (default)
			1 = output on
2	STR_MODE	R/W	0 = software strobe mode (software flash occurs when output is enabled in flash mode)
			1 = hardware strobe mode (the STROBE pin must go high for flash) (default)
[1:0]	LED_MOD	R/W	Configures LED output mode
			00 = standby mode (default)
			01 = voltage output mode, VOUT = 5 V
			10 = assist light mode
			11 = flash mode

Table 13. Output Mode Register (Register 0x04)

Table 14. Fault Information Register (Register 0x05)

Bit	Bit Name	R/W	Description
7	FL_OVP	R	0 = no fault (default)
			1 = overvoltage fault
6	FL_SC	R	0 = no fault (default)
			1 = short-circuit fault
5	FL_OT	R	0 = no fault (default)
			1 = overtemperature fault
4	FL_TO	R	0 = no fault (default)
			1 = timeout fault
3	FL_TX1	R	0 = no TxMASK1 operation mode during last flash (default)
			1 = TxMASK1 operational mode occurred during last flash
2	FL_IO2	R	If GPIO2 is configured as TxMASK2
			0 = no TxMASK2 operation mode during last flash (default)
			1 = TxMASK2 operational mode occurred during last flash
			If GPIO2 is configured as ILED
			0 = no fault (default)
			1 = indicator LED fault
1	FL_IL	R	0 = no fault (default)
			1 = inductor peak current-limit fault
0	FL_IDC	R	0 = programmed dc current limit is not hit (default)
			1 = programmed dc current limit is hit

Bit	Bit Name	R/W	Description
[7:4]	I_TX2	R/W	TxMASK2 operational mode foldback current
			0000 = 100 mA
			0001 = 150 mA
			0010 = 200 mA
			0011 = 250 mA
			0100 = 300 mA
			0101 = 350 mA
			0110 = 400 mA (default)
			0111 = 450 mA
			1000 = 500 mA
			1001 = 550 mA
			1010 = 600 mA
			1011 = 650 mA
			1100 = 700 mA
			1101 = 750 mA
			1110 = 800 mA
			1111 = 850 mA
[3:0]	I_TX1	R/W	TxMASK1 operational mode foldback current
			0000 = 100 mA
			0001 = 150 mA
			0010 = 200 mA
			0011 = 250 mA
			0100 = 300 mA
			0101 = 350 mA
			0110 = 400 mA (default)
			0111 = 450 mA
			1000 = 500 mA
			1001 = 550 mA
			1010 = 600 mA
			1011 = 650 mA
			1100 = 700 mA
			1101 = 750 mA
			1110 = 800 mA
			1111 = 850 mA

Table 15. Input Control Register (Register 0x06)

Bit	Bit Name	R/W	Description
7	DYN_OVP	R/W	Dynamic overvoltage protection (DOVP)
			0 = DOVP off (default)
			1 = DOVP on
6	SW_LO	R/W	Force 1.5 MHz switching frequency
			0 = disabled (default)
			1 = enabled
5	STR_POL	R/W	Strobe polarity
			0 = active low
			1 = active high (default)
[4:3]	I_ILED	R/W	Indicator LED current
			00 = 2.75 mA (default)
			01 = 5.5 mA
			10 = 8.25 mA
			11 = 11 mA
[2:1]	IL_DC	R/W	Input dc current limit setting the LED current
			00 = 1.5 A
			01 = 1.75 A
			10 = 2.0 A (default)
			11 = reserved
0	IL_DC_EN	R/W	Input dc current limit
			0 = disabled (default)
			1 = enabled

Table 16. Additional Mode Register, AD_MOD (Register 0x07)

Table 17. Additional Mode Register, ADC (Register 0x08)

Bit	Bit Name	R/W	Description
7	Reserved	R/W	Test mode
			0 = disabled (default)
			1 = enabled
6	FL_VB_LO	R	Programmed V _{BAT} low threshold status; low battery mode must be enabled in Register 0x09
			$0 = V_{DD}$ is greater than the V_{BAT} low threshold (default)
			$1 = V_{DD}$ is less than the V_{BAT} low threshold
[5:2]	ADC_VAL	R/W	ADC readback value; four bits (see Figure 16, Figure 17, and Figure 18)
[1:0]	ADC_EN	R/W	ADC enable mode
			00 = disabled (default)
			$01 = \text{LED V}_{\text{F}}$ measurement
			10 = die temperature measurement
			11 = external voltage mode

Bit	Bit Name	R/W	Description
7	CL_SOFT	R/W	Soft inductor peak current limit
			0 = disabled (ADP1649 is disabled when the inductor peak current limit is reached)
			1 = enabled (default)
[6:3]	I_VB_LO	R	Current setting for V _{BAT} low mode
			0000 = 300 mA
			0001 = 350 mA
			0010 = 400 mA
			0011 = 450 mA
			0100 = 500 mA
			0101 = 550 mA
			0110 = 600 mA
			0111 = 650 mA
			1000 = 700 mA
			1001 = 750 mA
			1010 = 800 mA (default)
			1011 = 850 mA
			1100 = 900 mA
			1101 = 950 mA
			1110 = 1000 mA
			1111 = reserved
[2:0]	V_VB_LO	R/W	V_{DD} level where V_{BAT} low function is enabled
			000 = disabled (default)
			001 = 3.3 V
			010 = 3.35 V
			011 = 3.4 V
			100 = 3.45 V
			101 = 3.5 V
			110 = 3.55 V
			111 = 3.6 V

Table 18. Battery Low Mode Register (Register 0x09)